

#### **Overview**

KEMET's Y5V dielectric features an 85°C maximum operating temperature and is considered "general-purpose." The Electronics Industries Alliance (EIA) characterizes Y5V dielectric as a Class III material. Components of this classification are fixed, ceramic dielectric capacitors, suited for bypass and decoupling or other applications in which dielectric losses, high insulation resistance and capacitance stability are not of major importance. Y5V exhibits a predictable change in capacitance with respect to time and voltage, and displays wide variations in capacitance with reference to ambient temperature. Capacitance change is limited to +22%, -82% from -30°C to +85°C.

#### **Benefits**

- -30°C to +85°C operating temperature range
- · Lead (Pb)-free, RoHS and REACH compliant
- EIA 0402, 0603, 0805, 1206, and 1210 case sizes
- DC voltage ratings of 6.3 V, 10 V, 16 V, 25 V, and 50 V
- Capacitance offerings ranging from 0.022  $\mu$ F to 22  $\mu$ F
- Available capacitance tolerance of ±20% and +80%/-20%
- · Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish that allows for excellent solderability

#### **Applications**

Typical applications include limited temperature, decoupling and bypass.



#### **Ordering Information**

| C       | 1210                                 | С                        | 226   | Z                         | 4   | V          | Α                       | С                               | TU   |
|---------|--------------------------------------|--------------------------|---|---------------------------|---|------------|-------------------------|---------------------------------|--|
| Ceramic | Case Size<br>(L" x W")               | Specification/<br>Series | Capacitance<br>Code (pF)                            | Capacitance<br>Tolerance  | Rated<br>Voltage<br>(VDC)                       | Dielectric | Failure Rate/<br>Design | Termination Finish <sup>1</sup> | Packaging/<br>Grade (C-Spec)                                 |
|         | 0402<br>0603<br>0805<br>1206<br>1210 | C = Standard             | Two significant<br>digits and<br>number of<br>zeros | M = ±20%<br>Z = +80%/-20% | 9 = 6.3<br>8 = 10<br>4 = 16<br>3 = 25<br>5 = 50 | V = Y5V    | A = N/A                 | C = 100% Matte Sn               | See<br>"Packaging<br>C-Spec<br>Ordering<br>Options<br>Table" |

<sup>1</sup> Additional termination finish options may be available. Contact KEMET for details.



#### Packaging C-Spec Ordering Options Table

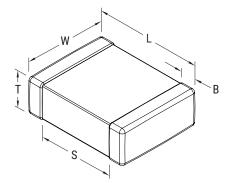
| Packaging Type <sup>1</sup>              | Packaging/Grade<br>Ordering Code (C-Spec)                                       |
|--|---|
| Bulk Bag/Unmarked                        | Not required (Blank)  |
| 7" Reel/Unmarked                         | TU  |
| 13" Reel/Unmarked                        | 7411 (EIA 0603 and smaller case sizes)<br>7210 (EIA 0805 and larger case sizes) |
| 7" Reel/Marked                           | ТМ  |
| 13" Reel/Marked                          | 7040 (EIA 0603)<br>7215 (EIA 0805 and larger case sizes)                        |
| 7" Reel/Unmarked/2mm pitch <sup>2</sup>  | 7081  |
| 13" Reel/Unmarked/2mm pitch <sup>2</sup> | 7082  |

<sup>1</sup> Default packaging is "Bulk Bag". An ordering code C-Spec is not required for "Bulk Bag" packaging.

<sup>1</sup> The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. Please contact KEMET if you require a laser marked option. For more information see "Capacitor Marking".

<sup>2</sup> The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".

#### **Dimensions – Millimeters (Inches)**



| EIA Size<br>Code | Metric Size<br>Code | L<br>Length                   | W<br>Width                    | T<br>Thickness               | B<br>Bandwidth                | S<br>Separation<br>Minimum | Mounting<br>Technique           |
|------------------|---------------------|-------------------------------|-------------------------------|------------------------------|-------------------------------|----------------------------|---------------------------------|
| 0402             | 1005                | 1.00 (0.040)<br>±0.05 (0.002) | 0.50 (0.020)<br>±0.05 (0.002) |                              | 0.30 (0.012)<br>±0.10 (0.004) | 0.30 (0.012)               | Solder Reflow<br>Only           |
| 0603             | 1608                | 1.60 (0.063)<br>±0.15 (0.006) | 0.80 (0.032)<br>±0.15 (0.006) |                              | 0.35 (0.014)<br>±0.15 (0.006) | 0.70 (0.028)               |                                 |
| 0805             | 2012                | 2.00 (0.079)<br>±0.20 (0.008) | 1.25 (0.049)<br>±0.20 (0.008) | See Table 2 for<br>Thickness | 0.50 (0.02)<br>±0.25 (0.010)  | 0.75 (0.030)               | Solder Wave or<br>Solder Reflow |
| 1206             | 3216                | 3.20 (0.126)<br>±0.20 (0.008) | 1.60 (0.063)<br>±0.20 (0.008) |                              | 0.50 (0.02)<br>±0.25 (0.010)  | N1/A                       |                                 |
| 1210             | 3225                | 3.20 (0.126)<br>±0.20 (0.008) | 2.50 (0.098)<br>±0.20 (0.008) |                              | 0.50 (0.02)<br>±0.25 (0.010)  | N/A                        | Solder Reflow<br>Only           |



#### **Qualification/Certification**

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

#### **Environmental Compliance**

Lead (Pb)-free, RoHS, and REACH compliant without exemptions.

### **Electrical Parameters/Characteristics**

| Item  | Parameters/Characteristics   |
|---|--|
| Operating Temperature Range   | -30°C to +85°C   |
| Capacitance Change with Reference to<br>+25°C and 0 Vdc Applied (TCC) | +22%, -82%   |
| <sup>1</sup> Aging Rate (Maximum % Capacitance Loss/Decade Hour)      | 7.0%   |
| <sup>2</sup> Dielectric Withstanding Voltage (DWV)                    | 250% of rated voltage<br>(5±1 seconds and charge/discharge not exceeding 50mA)             |
| <sup>3</sup> Dissipation Factor (DF) Maximum Limit at 25°C            | 10% (6.3 V and 10 V), 7% (16 V and 25 V) and 5% (50 V )                                    |
| <sup>4</sup> Insulation Resistance (IR) Minimum Limit at 25°C         | See Insulation Resistance Limit Table<br>(Rated voltage applied for 120±5 seconds at 25°C) |

<sup>1</sup> Regarding Aging Rate: Capacitance measurements (including tolerance) are indexed to a referee time of 48 or 1,000 hours. Please refer to a part number specific datasheet for referee time details.

<sup>2</sup>DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

<sup>3</sup> See part number specification sheet for frequency and voltage for Capacitance, Dissipation Factor, and TCC measurement conditions.

<sup>4</sup> To obtain IR limit, divide  $M\Omega$ - $\mu$ F value by the capacitance and compare to G $\Omega$  limit. Select the lower of the two limits.

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 & Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON".

## **Post Environmental Limits**

|            | High Temperature Life, Biased Humidity, Moisture Resistance |                      |                                   |                      |                          |  |  |  |  |  |  |  |
|------------|---|----------------------|-----------------------------------|----------------------|--------------------------|--|--|--|--|--|--|--|
| Dielectric | Rated DC<br>Voltage   | Capacitance<br>Value | Dissipation Factor<br>(Maximum %) | Capacitance<br>Shift | Insulation<br>Resistance |  |  |  |  |  |  |  |
|            | > 25  |                      | 7.5                               |                      |                          |  |  |  |  |  |  |  |
| Y5V        | 16/25   | All                  | 10.0                              | ±30%                 | 10% of Initial<br>Limit  |  |  |  |  |  |  |  |
|            | < 16  |                      | 15.0                              |                      |                          |  |  |  |  |  |  |  |



#### **Insulation Resistance Limit Table**

| EIA Case Size | 100 Megohm<br>Microfarads or 10 GΩ | 50 Megohm<br>Microfarads or 10 GΩ |
|---------------|------------------------------------|-----------------------------------|
| All           | ≥ 16 V                             | ≤ 10 V                            |

## Table 1 – Capacitance Range/Selection Waterfall (0402 – 1210 Case Sizes)

|                    |                     |            | Size/<br>ries  | C   | 040  | 2C |          | C06      | 030      | ;        |          | C        | 080      | 5C       |    |                 | <b>C</b> 1      | 120             | 6 <b>C</b> |    |                 | <b>C</b> 1      | 1210 | C  |    |
|--------------------|---------------------|------------|--|-----|------|----|----------|----------|----------|----------|----------|----------|----------|----------|----|-----------------|-----------------|-----------------|------------|----|-----------------|-----------------|------|----|----|
| Conscitones        | Capacitance         | Voltag     | je Code  | 9   | 8    | 4  | 9        | 8        | 4        | 3        | 9        | 8        | 4        | 3        | 5  | 9               | 8               | 4               | 3          | 5  | 9               | 8               | 4    | 3  | 5  |
| Capacitance        | Code                | Rated Vol  | tage (VDC)   | 6.3 | 10   | 16 | 6.3      | 10       | 16       | 25       | 6.3      | 10       | 16       | 25       | 50 | 6.3             | 10              | 16              | 25         | 50 | 6.3             | 10              | 16   | 25 | 50 |
|                    |                     | Capacitanc | Product Availability and Chip Thickness Codes<br>See Table 2 for Chip Thickness Dimensions |     |      |    |          |          |          | <u> </u> | <u> </u> |          |          |          |    |                 |                 |                 |            |    |                 |                 |      |    |    |
| 22,000 pF          | 223                 | М          | Z  | BB  | BB   | BB | CF       | CF       | CF       | CF       | DN       | DN       | DN       | DN       | DN |                 |                 |                 |            |    |                 |                 |      |    |    |
| 27,000 pF          | 273                 | М          | Z  | BB  | BB   | BB | CF       | CF       | CF       | CF       | DN       | DN       | DN       | DN       | DN |                 |                 |                 |            |    |                 |                 |      |    |    |
| 33,000 pF          | 333                 | М          | Z  | BB  | BB   | BB | CF       | CF       | CF       | CF       | DN       | DN       | DN       | DN       | DN |                 |                 |                 |            |    |                 |                 |      |    |    |
| 39,000 pF          | 393                 | М          | Z  | BB  | BB   | BB | CF       | CF       | CF       | CF       | DP       | DP       | DP       | DP       | DP |                 |                 |                 |            |    |                 |                 |      |    |    |
| 47,000 pF          | 473                 | M          | Z  | BB  | BB   | BB | CF       | CF       | CF       | CF       | DO       | DO       | DO       | DO       | DO |                 |                 |                 |            |    |                 |                 |      |    |    |
| 56,000 pF          | 563                 | М          | Z  | BB  | BB   | BB | CF       | CF       | CF       | CF       | DP       | DP       | DP       | DP       | DP |                 |                 |                 |            |    |                 |                 |      |    |    |
| 68,000 pF          | 683                 | M          | Z  | BB  | BB   | BB | CF       | CF       | CF       | CF       | DP       | DP       | DP       | DP       | DP |                 |                 |                 |            |    |                 |                 |      |    |    |
| 82,000 pF          | 823                 | M          | Z  | BB  | BB   | BB | CF       | CF       | CF       | CF       | DP       | DP       | DP       | DP       | DP |                 |                 |                 |            |    |                 |                 |      |    |    |
| 0.10 µF            | 104                 | M          | Z  | BB  | BB   | BB | CG       | CG       | CG       | CG       | DN       | DN       | DN       | DN       | DN |                 |                 |                 |            |    |                 |                 |      |    |    |
| 0.12 µF            | 124<br>154          | M          | ZZ   |     |      |    | CG<br>CG | CG       | CG<br>CG | CG<br>CG | DN<br>DN | DN<br>DN | DN<br>DN | DN<br>DN |    |                 |                 |                 |            |    |                 |                 |      |    |    |
| 0.15 µF            | 154<br>184          | M          | Z  |     |      |    | CG       | CG<br>CG |          |          |          | DN       | DN       | DN       |    |                 |                 |                 |            |    |                 |                 |      |    |    |
| 0.18 μF<br>0.22 μF | 224                 | M          | Z  | вв  |      |    | CG       | CG       | CG<br>CG | CG<br>CG | DN<br>DN | DN       | DN       | DN       | DG | EC              | EC              | EC              | EC         |    | FD              | FD              | FD   | FD | FD |
| 0.22 μF<br>0.27 μF | 274                 | M          | Z  |     |      |    | CG       | CG       | CG       | CG       | DN       | DN       | DN       | DN       | DG | EB              | EB              | EB              | EB         |    | FD              | FD              | FD   | FD | FD |
| 0.27 μF<br>0.33 μF | 334                 | M          | Z  |     |      |    | CG       | CG       | CG       | CG       | DG       | DG       | DIN      | DIN      |    | EB              | EB              | EB              | EB         |    | FD              | FD              | FD   | FD | FD |
| 0.35 µF<br>0.39 µF | 394                 | M          | Z  |     |      |    | CG       | CG       | CG       | 00       | DO       | DO       | DO       | DN       |    | EB              | EB              | EB              | EB         |    | FD              | FD              | FD   | FD | FD |
| 0.35 μF            | 474                 | M          | Z  | вв  |      |    | CG       | CG       | CG       |          | DG       | DG       | DG       | DG       |    | EC              | EC              | EC              | EC         |    | FD              | FD              | FD   | FD | FD |
| 0.56 μF            | 564                 | M          | Z  |     |      |    | CG       | CG       | 00       |          | DP       | DP       | DP       | DP       |    | EB              | EB              | EB              | EB         |    | FD              | FD              | FD   | FD | FD |
| 0.68 µF            | 684                 | M          | Z  |     |      |    | CG       | CG       |          |          | DP       | DP       | DP       | DG       |    | EB              | EB              | EB              | EB         |    | FD              | FD              | FD   | FD | FD |
| 0.82 µF            | 824                 | M          | Z  |     |      |    | CG       | CG       |          |          | DG       | DG       | DG       | DG       |    | EB              | EB              | EB              | EB         |    | FF              | FF              | FF   | FF | FF |
| 1.0 μF             | 105                 | M          | Z  | BB  | BB   |    | CG       | CG       | CG       | CG       | DP       | DP       | DP       | DG       | DG | EP              | EP              | EP              | EP         |    | FH              | FH              | FH   | FH | FH |
| 1.2 µF             | 125                 | M          | z  |     |      |    |          |          |          |          | DN       | DN       | DN       |          |    | EC              | EC              | EC              |            |    | FD              | FD              | FD   |    |    |
| 1.5 µF             | 155                 | M          | z  |     |      |    |          |          |          |          | DN       | DN       | DN       |          |    | EC              | EC              | EC              |            |    | FD              | FD              | FD   |    |    |
| 1.8 µF             | 185                 | M          | z  |     |      |    |          |          |          |          | DP       | DP       | DP       |          |    | ED              | ED              | ED              |            |    | FD              | FD              | FD   |    |    |
| 2.2 µF             | 225                 | M          | Z  | BB  | BB   |    |          |          |          |          | DG       | DG       | DG       |          |    | EC              | EC              | EC              |            |    | FJ              | FJ              | FJ   |    |    |
| 3.3 µF             | 335                 | M          | Z  |     |      |    |          |          |          |          | DL       | DL       | DG       |          |    | EH              | EH              | EH              |            |    | FE              | FE              | FE   |    |    |
| 4.7 μF             | 475                 | М          | Z  |     |      |    |          |          |          |          | DG       | DG       | DG       |          |    | EH <sup>2</sup> | EH <sup>2</sup> | EH <sup>2</sup> |            |    | FT              | FT              | FT   |    |    |
| 5.6 µF             | 565                 | М          | Z  | 1   |      |    | l I      |          |          |          | DF       | DF       |          |          |    | EJ              | EJ              | EJ              |            |    | FG              | FG              | FG   |    |    |
| 6.8 µF             | 685                 | М          | Z  |     |      |    |          |          |          |          | DG       | DG       |          |          |    | EJ              | EJ              |                 |            |    | FH              | FH              | FH   |    |    |
| 10 µF              | 106                 | М          | Z  |     |      |    |          |          |          |          | DG       | DG       |          |          |    | EH              | EH              | EH              | EH         |    | FT2             | FT2             | FT2  |    |    |
| 15 µF              | 156                 | М          | Z  |     |      |    |          |          |          |          |          |          |          |          |    |                 |                 |                 |            |    | FH              | FH              | FH   |    |    |
| 22 µF              | 226                 | М          | Z  |     |      |    |          |          |          |          |          |          |          |          |    | EH              | EH              |                 |            |    | FT <sup>2</sup> | FT <sup>2</sup> | FS   | FS |    |
|                    |                     | Rated Vol  | tage (VDC)   | 6.3 | 9    | 16 | 6.3      | 10       | 16       | 25       | 6.3      | 9        | 16       | 25       | 50 | 6.3             | 9               | 16              | 25         | 50 | 6.3             | 10              | 16   | 25 | 50 |
| Capacitance        | Capacitance<br>Code | Voltag     | je Code  | 9   | 8    | 4  | 9        | 8        | 4        | 3        | 9        | 8        | 4        | 3        | 5  | 9               | 8               | 4               | 3          | 5  | 9               | 8               | 4    | 3  | 5  |
| -                  | Coue                |            | Size/<br>ries  | C   | 0402 | 20 |          | C06      | 03C      |          |          | C        | 0805     | 5C       |    |                 | C               | 1206            | C          |    |                 | C               | 1210 | C  |    |

xx<sup>2</sup> Only available in Z tolerance.



| Thickness | Case  | Thickness ±  | Paper Q | uantity <sup>1</sup> | Plastic (        | Quantity |  |  |
|-----------|-------|--------------|---------|----------------------|------------------|----------|--|--|
| Code      | Size  | Range (mm)   | 7" Reel | 13" Reel             | 7" Reel          | 13" Reel |  |  |
| BB        | 0402  | 0.50 ± 0.05  | 10,000  | 50,000               | 0                | 0        |  |  |
| CF        | 0603  | 0.80 ± 0.07* | 4,000   | 15,000               | 0                | 0        |  |  |
| CG        | 0603  | 0.80 ± 0.10* | 4,000   | 15,000               | 0                | 0        |  |  |
| DN        | 0805  | 0.78 ± 0.10* | 4,000   | 15,000               | 0                | 0        |  |  |
| DO        | 0805  | 0.80 ± 0.10* | 4,000   | 15,000               | 0                | 0        |  |  |
| DP        | 0805  | 0.90 ± 0.10* | 4,000   | 15,000               | 0                | 0        |  |  |
| DL        | 0805  | 0.95 ± 0.10  | 0       | 0                    | 4,000            | 10,000   |  |  |
| DF        | 0805  | 1.10 ± 0.10  | 0       | 0                    | 2,500            | 10,000   |  |  |
| DG        | 0805  | 1.25 ± 0.15  | 0       | 0                    | 2,500            | 10,000   |  |  |
| EB        | 1206  | 0.78 ± 0.10  | 0       | 0                    | 4,000            | 10,000   |  |  |
| EC        | 1206  | 0.90 ± 0.10  | 0       | 0                    | 4,000            | 10,000   |  |  |
| ED        | 1206  | 1.00 ± 0.10  | 0       | 0                    | 2,500            | 10,000   |  |  |
| EP        | 1206  | 1.20 ± 0.20  | 0       | 0                    | 2,500            | 10,000   |  |  |
| EH        | 1206  | 1.60 ± 0.20  | 0       | 0                    | 2,000            | 8,000    |  |  |
| EJ        | 1206  | 1.70 ± 0.20  | 0       | 0                    | 2,000            | 8,000    |  |  |
| FD        | 1210  | 0.95 ± 0.10  | 0       | 0                    | 4,000            | 10,000   |  |  |
| FE        | 1210  | 1.00 ± 0.10  | 0       | 0                    | 2,500            | 10,000   |  |  |
| FF        | 1210  | 1.10 ± 0.10  | 0       | 0                    | 2,500            | 10,000   |  |  |
| FG        | 1210  | 1.25 ± 0.15  | 0       | 0                    | 2,500            | 10,000   |  |  |
| FH        | 1210  | 1.55 ± 0.15  | 0       | 0                    | 2,000            | 8,000    |  |  |
| FJ        | 1210  | 1.85 ± 0.20  | 0       | 0                    | 2,000            | 8,000    |  |  |
| FT        | 1210  | 1.90 ± 0.20  | 0       | 0                    | 2,000            | 8,000    |  |  |
| FS        | 1210  | 2.50 ± 0.30  | 0       | 0                    | 1,000            | 4,000    |  |  |
| Thickness | Case  | Thickness ±  | 7" Reel | 13" Reel             | 7" Reel          | 13" Reel |  |  |
| Code      | Size1 | Range (mm)   | Paper Q | uantity <sup>1</sup> | Plastic Quantity |          |  |  |

#### Table 2A – Chip Thickness/Tape & Reel Packaging Quantities

Package quantity based on finished chip thickness specifications.

<sup>1</sup> If ordering using the 2 mm Tape and Reel pitch option, the packaging quantity outlined in the table above will be doubled. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".



#### Table 2B – Bulk Packaging Quantities

| Deeker   | ing Tune               | Loose Pa               | ackaging               |  |  |  |  |
|----------|------------------------|------------------------|------------------------|--|--|--|--|
| Раскад   | ing Type               | Bulk Bag (default)     |                        |  |  |  |  |
| Packagir | Ig C-Spec <sup>1</sup> | N/                     | /A²                    |  |  |  |  |
| Case     | e Size                 | Packaging Quantities ( | pieces/unit packaging) |  |  |  |  |
| EIA (in) | Metric (mm)            | Minimum                | Maximum                |  |  |  |  |
| 0402     | 1005                   |                        |                        |  |  |  |  |
| 0603     | 1608                   |                        |                        |  |  |  |  |
| 0805     | 2012                   |                        | 50,000                 |  |  |  |  |
| 1206     | 3216                   |                        |                        |  |  |  |  |
| 1210     | 3225                   | 1                      |                        |  |  |  |  |
| 1808     | 4520                   |                        |                        |  |  |  |  |
| 1812     | 4532                   |                        |                        |  |  |  |  |
| 1825     | 4564                   |                        | 20,000                 |  |  |  |  |
| 2220     | 5650                   |                        |                        |  |  |  |  |
| 2225     | 5664                   |                        |                        |  |  |  |  |

<sup>1</sup> The "Packaging C-Spec" is a 4 to 8 digit code which identifies the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial Grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for Automotive Grade products.

<sup>2</sup> A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding Anti-Static Bulk Bag and Automotive Grade products). The 15th through 22nd character positions of the ordering code should be left blank. All product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging.



#### Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC-7351

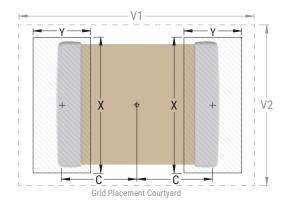
| EIA<br>Size<br>Code | Metric<br>Size<br>Code | Density Level A:<br>Maximum (Most)<br>Land Protrusion (mm) |      |      |      |      |      | Media | sity Lev<br>an (Nor<br>rotrusio |      | )    | Density Level C:<br>Minimum (Least)<br>Land Protrusion (mm) |      |      |      |      |  |
|---------------------|------------------------|--|------|------|------|------|------|-------|---------------------------------|------|------|---|------|------|------|------|--|
| Coue                | Coue                   | C  | Y    | X    | V1   | V2   | C    | Y     | X                               | V1   | V2   | C   | Y    | X    | V1   | V2   |  |
| 0402                | 1005                   | 0.50   | 0.72 | 0.72 | 2.20 | 1.20 | 0.45 | 0.62  | 0.62                            | 1.90 | 1.00 | 0.40  | 0.52 | 0.52 | 1.60 | 0.80 |  |
| 0603                | 1608                   | 0.90   | 1.15 | 1.10 | 4.00 | 2.10 | 0.80 | 0.95  | 1.00                            | 3.10 | 1.50 | 0.60  | 0.75 | 0.90 | 2.40 | 1.20 |  |
| 0805                | 2012                   | 1.00   | 1.35 | 1.55 | 4.40 | 2.60 | 0.90 | 1.15  | 1.45                            | 3.50 | 2.00 | 0.75  | 0.95 | 1.35 | 2.80 | 1.70 |  |
| 1206                | 3216                   | 1.60   | 1.35 | 1.90 | 5.60 | 2.90 | 1.50 | 1.15  | 1.80                            | 4.70 | 2.30 | 1.40  | 0.95 | 1.70 | 4.00 | 2.00 |  |
| 1210                | 3225                   | 1.60   | 1.35 | 2.80 | 5.65 | 3.80 | 1.50 | 1.15  | 2.70                            | 4.70 | 3.20 | 1.40  | 0.95 | 2.60 | 4.00 | 2.90 |  |
| 1210 <sup>1</sup>   | 3225                   | 1.50   | 1.60 | 2.90 | 5.60 | 3.90 | 1.40 | 1.40  | 2.80                            | 4.70 | 3.30 | 1.30  | 1.20 | 2.70 | 4.00 | 3.00 |  |

#### <sup>1</sup> Only for capacitance values $\ge 22 \ \mu F$

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805, and 1206 case sizes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for an EIA 1210 case size.





#### **Soldering Process**

#### **Recommended Soldering Technique:**

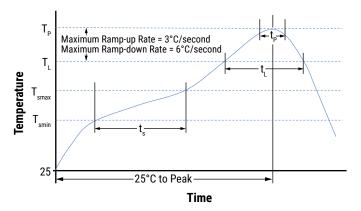
- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

#### **Recommended Reflow Soldering Profile:**

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

| Profile Feature  | Terminat              | ion Finish            |  |  |
|--|-----------------------|-----------------------|--|--|
| Tomereature  | SnPb                  | 100% Matte Sn         |  |  |
| Preheat/Soak   |                       |                       |  |  |
| Temperature Minimum (T <sub>Smin</sub> )                         | 100°C                 | 150°C                 |  |  |
| Temperature Maximum (T <sub>Smax</sub> )                         | 150°C                 | 200°C                 |  |  |
| Time ( $t_s$ ) from $T_{smin}$ to $T_{smax}$                     | 60 – 120 seconds      | 60 – 120 seconds      |  |  |
| Ramp-Up Rate (T <sub>L</sub> to T <sub>p</sub> )                 | 3°C/second<br>maximum | 3°C/second<br>maximum |  |  |
| Liquidous Temperature $(T_L)$                                    | 183°C                 | 217°C                 |  |  |
| Time Above Liquidous ( $t_L$ )                                   | 60 – 150 seconds      | 60 – 150 seconds      |  |  |
| Peak Temperature (T <sub>P</sub> )                               | 235°C                 | 260°C                 |  |  |
| Time Within 5°C of Maximum<br>Peak Temperature (t <sub>p</sub> ) | 20 seconds<br>maximum | 30 seconds<br>maximum |  |  |
| Ramp-Down Rate $(T_p to T_L)$                                    | 6°C/second<br>maximum | 6°C/second<br>maximum |  |  |
| Time 25°C to Peak<br>Temperature                                 | 6 minutes<br>maximum  | 8 minutes<br>maximum  |  |  |

Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.





### Table 4 – Performance & Reliability: Test Methods and Conditions

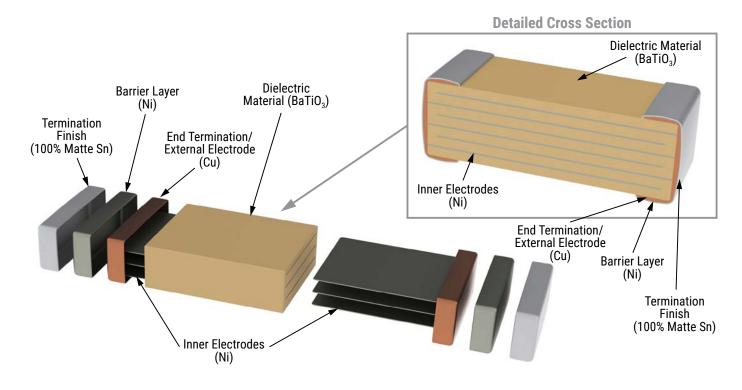
| Stress                 | Reference                         | Test or Inspection Method  |
|------------------------|-----------------------------------|--|
| Terminal Strength      | JIS-C-6429                        | Appendix 1, Note: Force of 1.8 kg for 60 seconds.  |
| Board Flex             | JIS-C-6429                        | Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for COG. Flexible termination system – 3.0 mm (minimum).  |
|                        |                                   | Magnification 50 X. Conditions:  |
| Solderability          | J-STD-002                         | a) Method B, 4 hours at 155°C, dry heat at 235°C   |
| Soluerability          | J-31D-002                         | b) Method B at 215°C category 3  |
|                        |                                   | c) Method D, category 3 at 260°C   |
| Temperature Cycling    | JESD22<br>Method JA-104           | 1,000 Cycles (-55°C to +125°C). Measurement at 24 hours +/- 4 hours after test conclusion.   |
| Dissed Humidity        | MIL-STD-202                       | Load Humidity: 1,000 hours 85°C/85% RH and rated voltage. Add 100 K ohm resistor.<br>Measurement at 24 hours +/- 4 hours after test conclusion.  |
| Biased Humidity        | Method 103                        | Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor.<br>Measurement at 24 hours +/- 4 hours after test conclusion.  |
| Moisture Resistance    | MIL-STD-202<br>Method 106         | t = 24 hours/cycle. Steps 7a and 7b not required.<br>Measurement at 24 hours +/- 4 hours after test conclusion.  |
| Thermal Shock          | MIL-STD-202<br>Method 107         | -55°C/+125°C. Note: Number of cycles required – 300, maximum transfer time – 20 seconds, dwell time – 15 minutes. Air – Air.   |
| High Temperature Life  | MIL-STD-202<br>Method 108/EIA-198 | 1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.   |
| Storage Life           | MIL-STD-202<br>Method 108         | 150°C, 0 VDC for 1,000 hours.  |
| Vibration              | MIL-STD-202<br>Method 204         | 5 g's for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8" X 5" PCB 0.031" thick<br>7 secure points on one long side and 2 secure points at corners of opposite sides. Parts<br>mounted within 2" from any secure point. Test from 10 – 2,000 Hz |
| Mechanical Shock       | MIL-STD-202<br>Method 213         | Figure 1 of Method 213, Condition F.   |
| Resistance to Solvents | MIL-STD-202<br>Method 215         | Add aqueous wash chemical, OKEM Clean or equivalent.   |

#### **Storage and Handling**

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature-reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



### **Construction (Typical)**



#### **Capacitor Marking (Optional)**

Laser marking option is not available on:

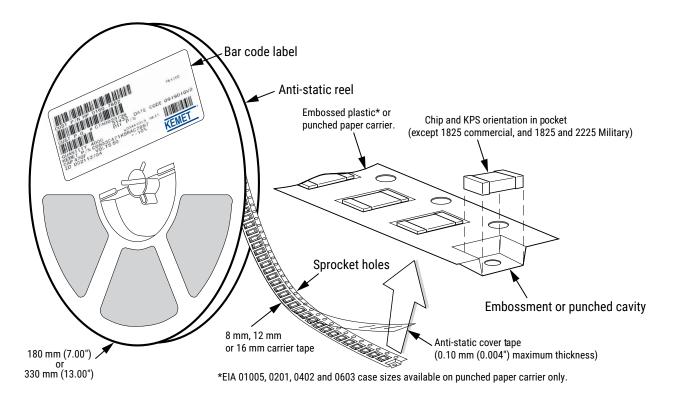
- COG, Ultra Stable X8R and Y5V dielectric devices
- · EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.



#### **Tape & Reel Packaging Information**

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.



## Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

|                      | Таре         | <b>Embossed Plastic</b>  |          | Punched Paper            |          |  |
|----------------------|--------------|--------------------------|----------|--------------------------|----------|--|
| EIA Case Size        | Size<br>(W)* | 7" Reel                  | 13" Reel | 7" Reel                  | 13" Reel |  |
|                      |              | Pitch (P <sub>1</sub> )* |          | Pitch (P <sub>1</sub> )* |          |  |
| 01005 - 0402         | 8            |                          |          | 2                        | 2        |  |
| 0603                 | 8            |                          |          | 2/4                      | 2/4      |  |
| 0805                 | 8            | 4                        | 4        | 4                        | 4        |  |
| 1206 - 1210          | 8            | 4                        | 4        | 4                        | 4        |  |
| 1805 - 1808          | 12           | 4                        | 4        |                          |          |  |
| ≥ 1812               | 12           | 8                        | 8        |                          |          |  |
| KPS 1210             | 12           | 8                        | 8        |                          |          |  |
| KPS 1812<br>and 2220 | 16           | 12                       | 12       |                          |          |  |
| Array 0612           | 8            | 4                        | 4        |                          |          |  |

\*Refer to Figures 1 and 2 for W and  $P_1$  carrier tape reference locations. \*Refer to Tables 6 and 7 for tolerance specifications.

#### New 2 mm Pitch Reel Options\*

| Packaging<br>Ordering Code<br>(C-Spec) | Packaging Type/Options             |
|--|------------------------------------|
| C-3190                                 | Automotive grade 7" reel unmarked  |
| C-3191                                 | Automotive grade 13" reel unmarked |
| C-7081                                 | Commercial grade 7" reel unmarked  |
| C-7082                                 | Commercial grade 13" reel unmarked |

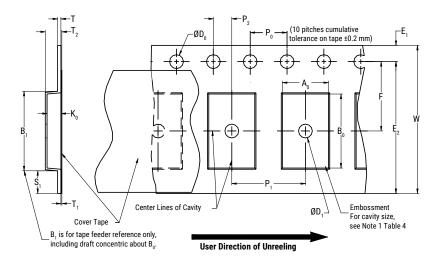
\* 2 mm pitch reel only available for 0603 EIA case size. 2 mm pitch reel for 0805 EIA case size under development.

#### Benefits of Changing from 4 mm to 2 mm Pitching Spacing

- Lower placement costs.
- Double the parts on each reel results in fewer reel changes and increased efficiency.
- Fewer reels result in lower packaging, shipping and storage costs, reducing waste.



## Figure 1 – Embossed (Plastic) Carrier Tape Dimensions



## Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

| Constant Dimensions – Millimeters (Inches) |                                       |                                  |                              |                             |                              |                           |                                  |                                |                           |
|--|---------------------------------------|----------------------------------|------------------------------|-----------------------------|------------------------------|---------------------------|----------------------------------|--------------------------------|---------------------------|
| Tape Size                                  | D <sub>0</sub>                        | D <sub>1</sub> Minimum<br>Note 1 | E <sub>1</sub>               | P <sub>0</sub>              | P <sub>2</sub>               | R Reference<br>Note 2     | S <sub>1</sub> Minimum<br>Note 3 | T<br>Maximum                   | T <sub>1</sub><br>Maximum |
| 8 mm                                       |                                       | 1.0<br>(0.039)                   |                              |                             |                              | 25.0<br>(0.984)           |                                  |                                |                           |
| 12 mm                                      | 1.5 +0.10/-0.0<br>(0.059 +0.004/-0.0) | 1.5                              | 1.75 ±0.10<br>(0.069 ±0.004) | 4.0 ±0.10<br>(0.157 ±0.004) | 2.0 ±0.05<br>(0.079 ±0.002)  | 30                        | 0.600<br>(0.024)                 | 0.600<br>(0.024)               | 0.100<br>(0.004)          |
| 16 mm                                      |                                       | (0.059)                          |                              |                             |                              | (1.181)                   |                                  |                                |                           |
|  |                                       | ,                                | Variable Dime                | ensions — Mil               | limeters (Inch               | nes)                      |                                  |                                |                           |
| Tape Size                                  | Pitch                                 | B <sub>1</sub> Maximum<br>Note 4 | E <sub>2</sub><br>Minimum    | F                           | P <sub>1</sub>               | T <sub>2</sub><br>Maximum | W<br>Maximum                     | A <sub>0</sub> ,B <sub>0</sub> | & K <sub>0</sub>          |
| 8 mm                                       | Single (4 mm)                         | 4.35<br>(0.171)                  | 6.25<br>(0.246)              | 3.5 ±0.05<br>(0.138 ±0.002) | 4.0 ±0.10<br>(0.157 ±0.004)  | 2.5<br>(0.098)            | 8.3<br>(0.327)                   |                                |                           |
| 12 mm                                      | Single (4 mm)<br>and double (8 mm)    | 8.2<br>(0.323)                   | 10.25<br>(0.404)             | 5.5 ±0.05<br>(0.217 ±0.002) | 8.0 ±0.10<br>(0.315 ±0.004)  | 4.6<br>(0.181)            | 12.3<br>(0.484)                  | Not                            | te 5                      |
| 16 mm                                      | Triple (12 mm)                        | 12.1<br>(0.476)                  | 14.25<br>(0.561)             | 7.5 ±0.05<br>(0.138 ±0.002) | 12.0 ±0.10<br>(0.157 ±0.004) | 4.6<br>(0.181)            | 16.3<br>(0.642)                  |                                |                           |

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of the embossment location and the hole location shall be applied independently of each other.

2. The tape with or without components shall pass around R without damage (see Figure 6.)

3. If S<sub>1</sub> < 1.0 mm, there may not be enough area for a cover tape to be properly applied (see EIA Standard 481, paragraph 4.3, section b.)

4. B, dimension is a reference dimension for tape feeder clearance only.

5. The cavity defined by  $A_{\mu}$ ,  $B_{\mu}$  and  $K_{\mu}$  shall surround the component with sufficient clearance that:

(a) the component does not protrude above the top surface of the carrier tape.

(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

(c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3.)

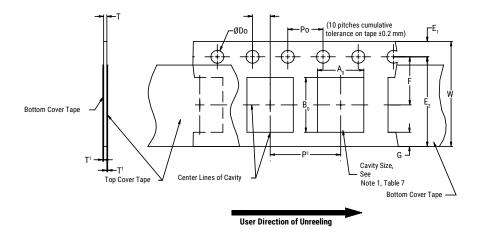
(d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4.)

(e) for KPS product,  $A_{n}$  and  $B_{n}$  are measured on a plane 0.3 mm above the bottom of the pocket.

(f) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.



#### Figure 2 – Punched (Paper) Carrier Tape Dimensions



## Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

| Constant Dimensions — Millimeters (Inches) |  |                              |                             |                             |                            |                 |                       |  |
|--|--|------------------------------|-----------------------------|-----------------------------|----------------------------|-----------------|-----------------------|--|
| Tape Size                                  | D <sub>0</sub>   | E <sub>1</sub>               | P <sub>0</sub>              | P <sub>2</sub>              | T <sub>1</sub> Maximum     | G Minimum       | R Reference<br>Note 2 |  |
| 8 mm                                       | 1.5 +0.10 -0.0<br>(0.059 +0.004 -0.0)                        | 1.75 ±0.10<br>(0.069 ±0.004) | 4.0 ±0.10<br>(0.157 ±0.004) | 2.0 ±0.05<br>(0.079 ±0.002) | 0.10<br>(0.004)<br>maximum | 0.75<br>(0.030) | 25<br>(0.984)         |  |
|  | Variable Dimensions – Millimeters (Inches)                   |                              |                             |                             |                            |                 |                       |  |
| Tape Size                                  | Tape SizePitchE2 MinimumF $P_1$ T MaximumW Maximum $A_0 B_0$ |                              |                             |                             |                            |                 |                       |  |
| 8 mm                                       | Half (2 mm)  | 6.25                         | 3.5 ±0.05<br>(0.138 ±0.002) | 2.0 ±0.05<br>(0.079 ±0.002) | 1.1<br>(0.098)             | 8.3<br>(0.327)  | Note 1                |  |
| 8 mm                                       | Single (4 mm)  | (0.246)                      |                             | 4.0 ±0.10<br>(0.157 ±0.004) |                            | 8.3<br>(0.327)  | Note I                |  |

1. The cavity defined by  $A_{\alpha}$ ,  $B_{\alpha}$  and T shall surround the component with sufficient clearance that:

a) the component does not protrude beyond either surface of the carrier tape.

b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

c) rotation of the component is limited to 20° maximum (see Figure 3.)

d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4.)

e) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.

2. The tape with or without components shall pass around R without damage (see Figure 6.)



#### **Packaging Information Performance Notes**

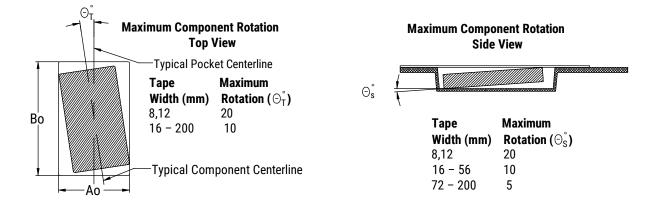
- 1. Cover Tape Break Force: 1.0 kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

| Tape Width   | Peel Strength                    |  |  |
|--------------|----------------------------------|--|--|
| 8 mm         | 0.1 to 1.0 newton (10 to 100 gf) |  |  |
| 12 and 16 mm | 0.1 to 1.3 newton (10 to 130 gf) |  |  |

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be  $165^{\circ}$  to  $180^{\circ}$  from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of  $300 \pm 10$  mm/minute.

**3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

#### Figure 3 – Maximum Component Rotation



#### Figure 4 – Maximum Lateral Movement

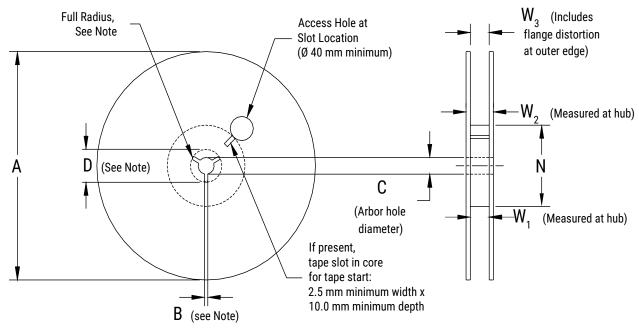


#### Figure 5 – Bending Radius





#### **Figure 6 – Reel Dimensions**



Note: Drive spokes optional; if used, dimensions B and D shall apply.

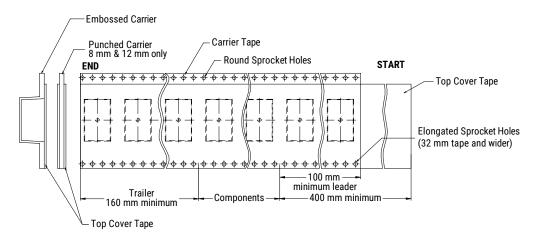
#### Table 8 – Reel Dimensions

Metric will govern

|           | Constant Dimensions — Millimeters (Inches) |                                       |  |  |  |  |  |  |
|-----------|--|---------------------------------------|--|--|--|--|--|--|
| Tape Size | А  | B Minimum                             | С                                      | D Minimum  |  |  |  |  |
| 8 mm      | 178 ±0.20                                  |                                       | 13.0 +0.5/-0.2<br>(0.521 +0.02/-0.008) | 20.2<br>(0.795)                                      |  |  |  |  |
| 12 mm     | (7.008 ±0.008)<br>or                       | 1.5<br>(0.059)                        |  |  |  |  |  |  |
| 16 mm     | 330 ±0.20<br>(13.000 ±0.008)               |                                       | ()                                     | ()   |  |  |  |  |
|           | Variable Dimensions – Millimeters (Inches) |                                       |  |  |  |  |  |  |
| Tape Size | N Minimum                                  | W <sub>1</sub>                        | W <sub>2</sub> Maximum                 | W <sub>3</sub>                                       |  |  |  |  |
| 8 mm      |  | 8.4 +1.5/-0.0<br>(0.331 +0.059/-0.0)  | 14.4<br>(0.567)                        |  |  |  |  |  |
| 12 mm     | 50<br>(1.969)                              | 12.4 +2.0/-0.0<br>(0.488 +0.078/-0.0) | 18.4<br>(0.724)                        | Shall accommodate tape<br>width without interference |  |  |  |  |
| 16 mm     |  | 16.4 +2.0/-0.0<br>(0.646 +0.078/-0.0) | 22.4<br>(0.882)                        |  |  |  |  |  |



#### Figure 7 – Tape Leader & Trailer Dimensions



## Figure 8 – Maximum Camber





#### **KEMET Electronics Corporation Sales Offices**

For a complete list of our global sales offices, please visit www.kemet.com/sales.

#### Disclaimer

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed. All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

KEMET is a registered trademark of KEMET Electronics Corporation.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Multilayer Ceramic Capacitors MLCC - Leaded category:

Click to view products by Kemet manufacturer:

Other Similar products are found below :

010-007220-002REV A M39014/01-1210V M39014/01-1281V M39014/01-1330 M39014/01-1335V M39014/01-1571V M39014/01-1578V M39014/01-1593 M39014/02-1265V M39014/02-1347 M39014/02-1350 M39014/22-0167 M39014/22-0734 87043-49 Q52-DK C410C221K1G5TATR C420C102J1G5TATR C430C104M1U5TATR FK26X7R2E104KN006 CCR05CG102JP CCR06CG183GRV CFB1/2C101J CFB1/2C102J CN20C102K M39014/01-1317 M39014/01-1572V M39014/01-1594V M39014/02-1236 M39014/02-1321V M39014/02-1345V M39014/22-0351 M39014/22-0695 M39014/220767 M39014/220788 M39014/22-1005 MA405E334MAA MD015A103KAB SL301E105MAB CCR05CG242FRV KTD101B684M32A0B00 CCR07CG473KR CCR05CG820JP TKC-TMC1206-05-1501-J?? TKC-TMC1206-05-1801-J TKC-TMC1206-05-20R0-F TKC-TMC1206-05-3901-J TKC-TMC1206-05-44R2-F TKC-TMC1206-05-4703-J?? TKC-TMC2512-05-1211-F 100B5R1CT500X